

FIG. 1A

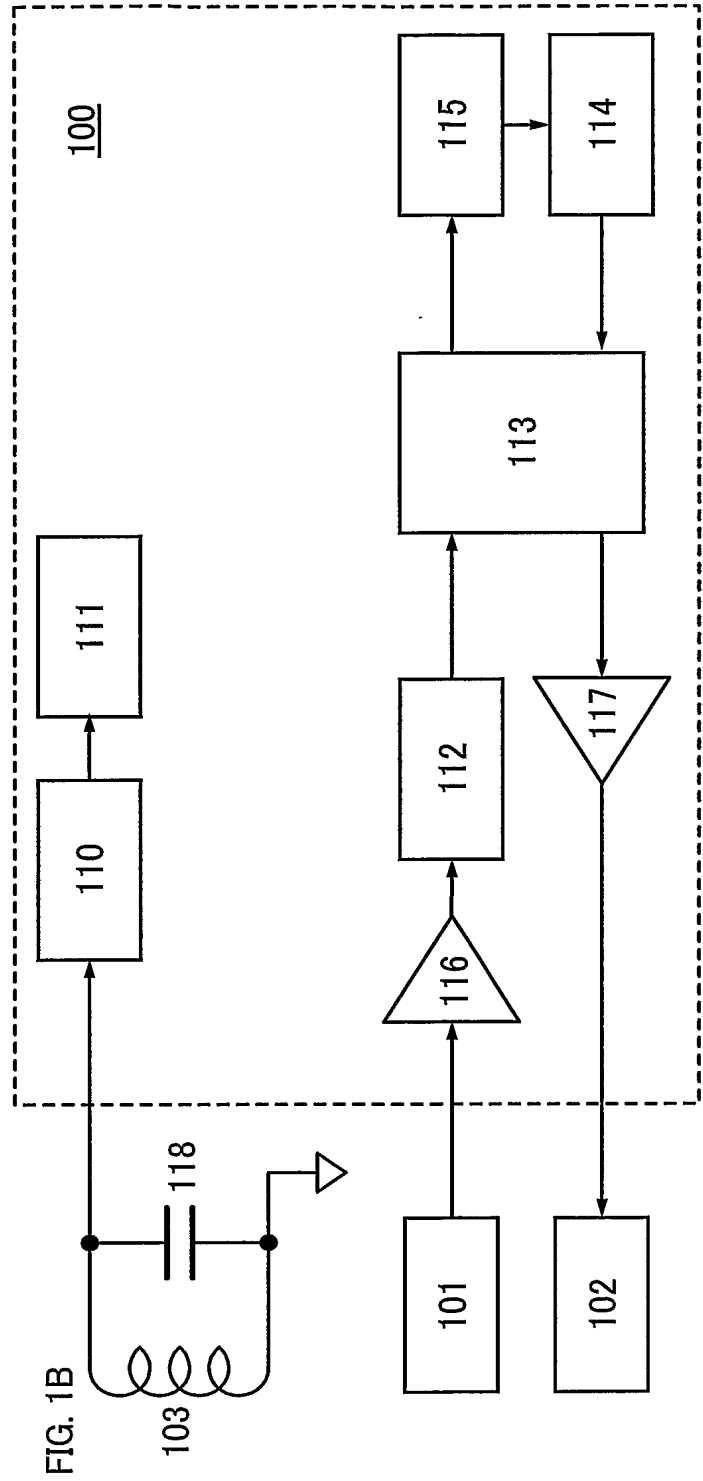


FIG. 1B

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FIG. 2A

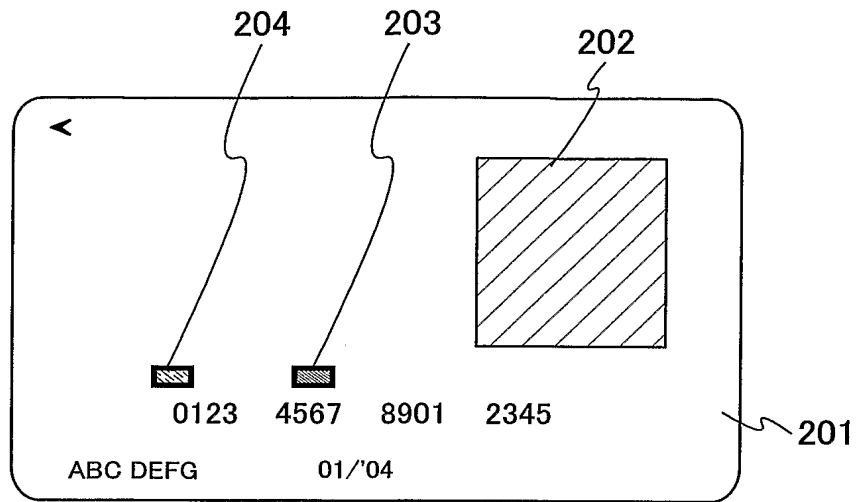
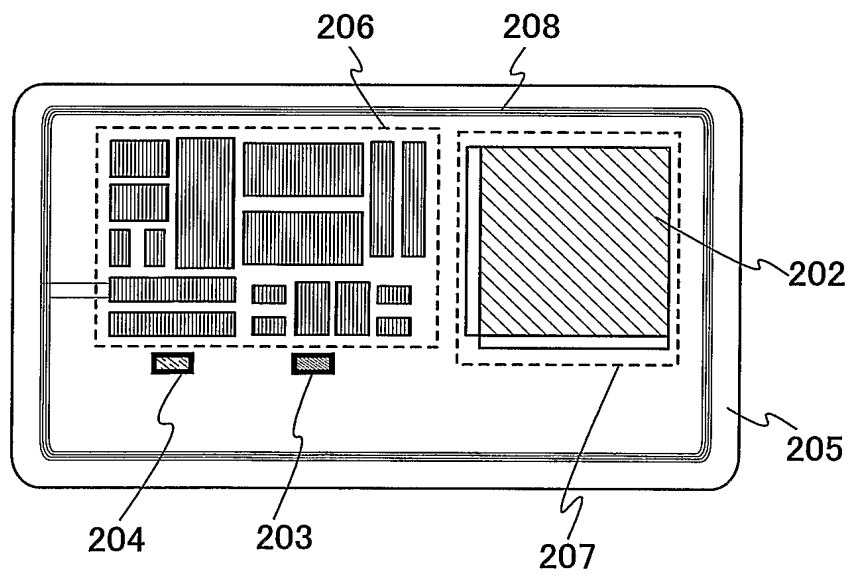


FIG. 2B



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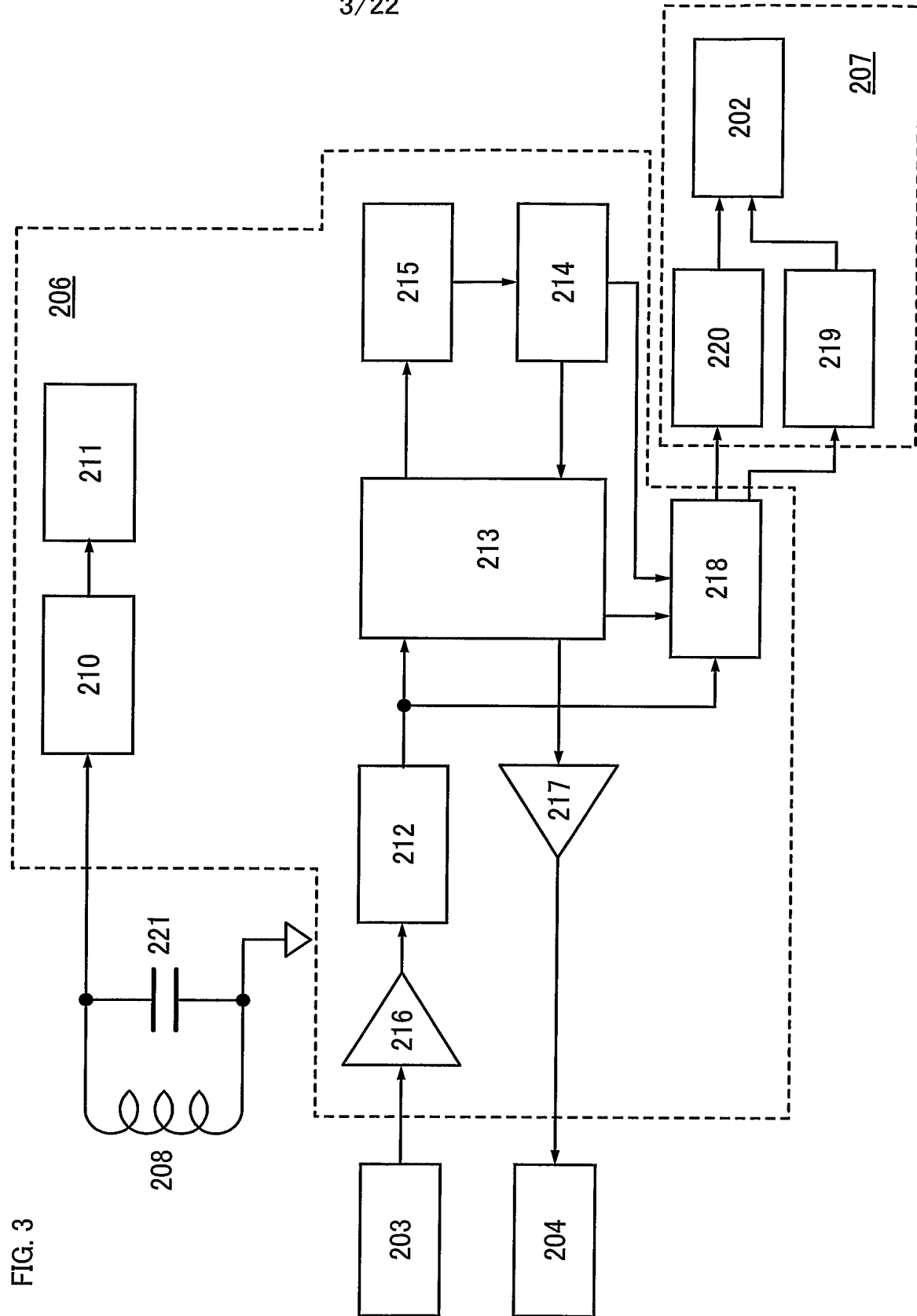


FIG. 3

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FIG. 4A

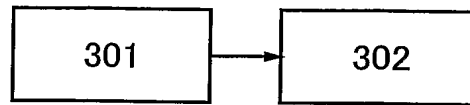
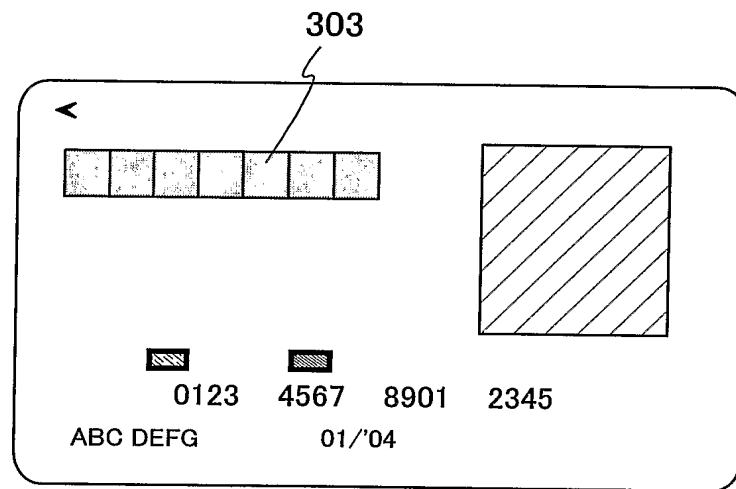
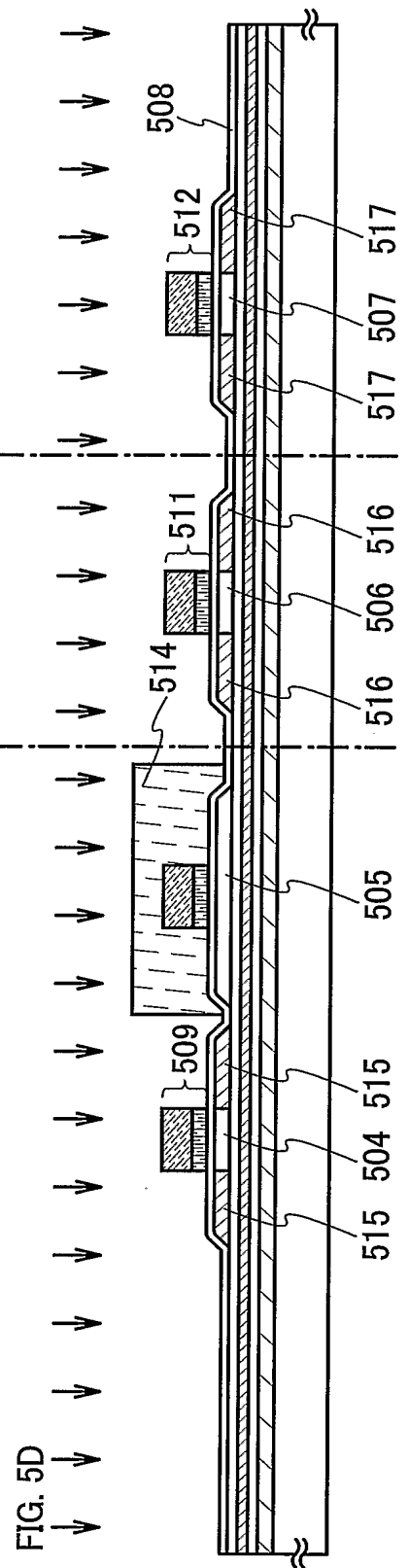
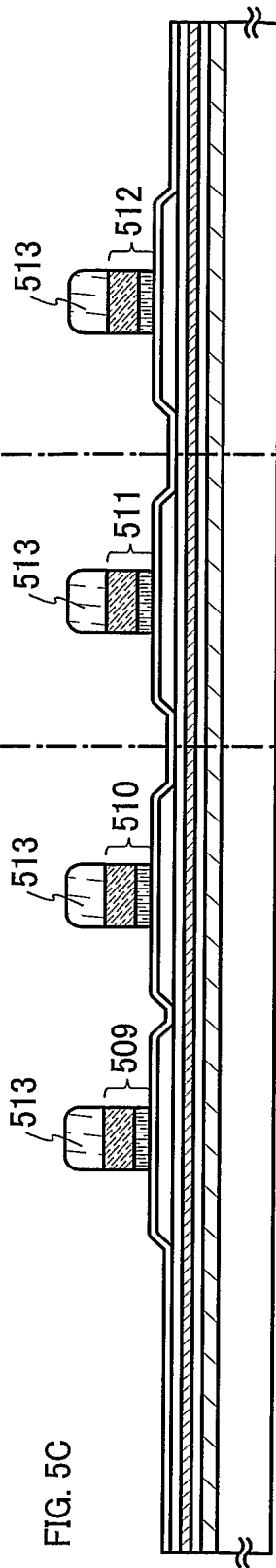
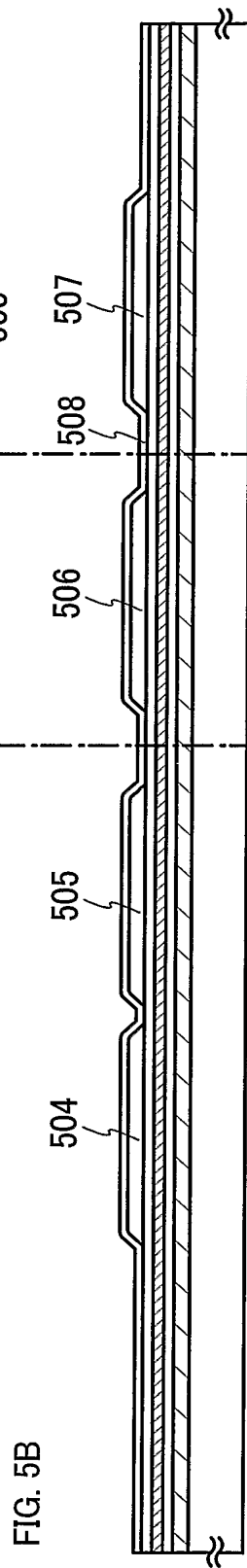
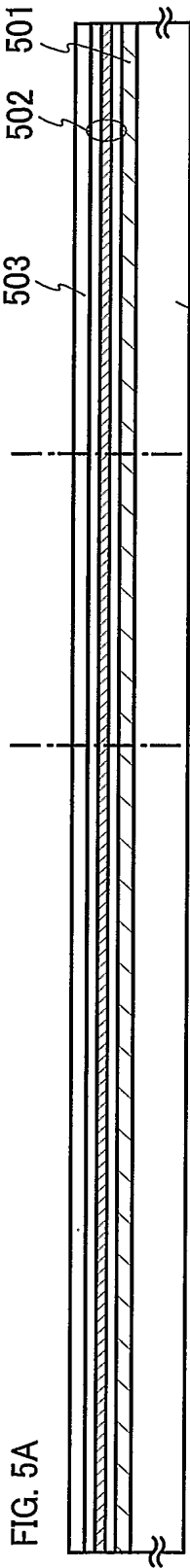
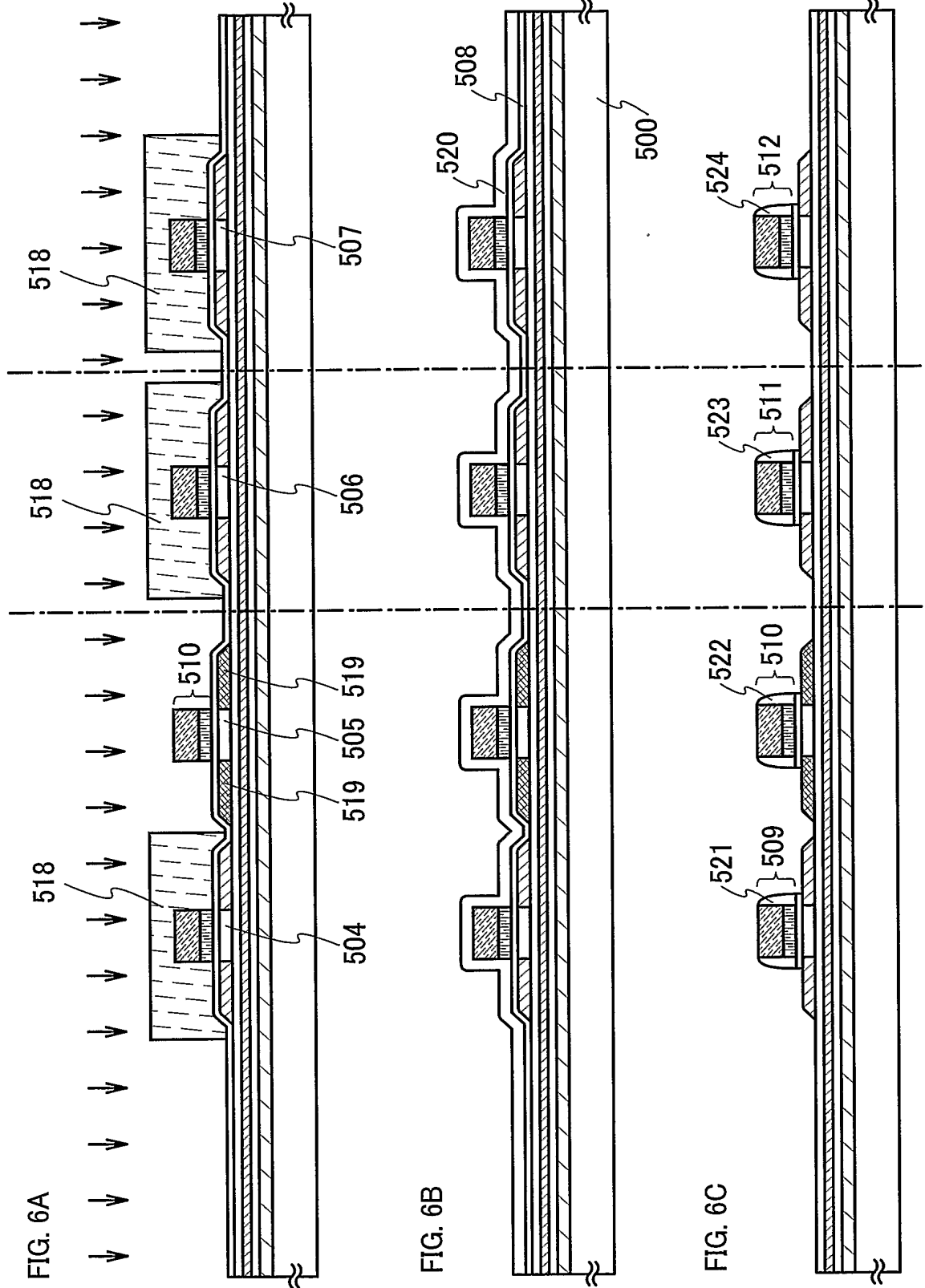


FIG.B



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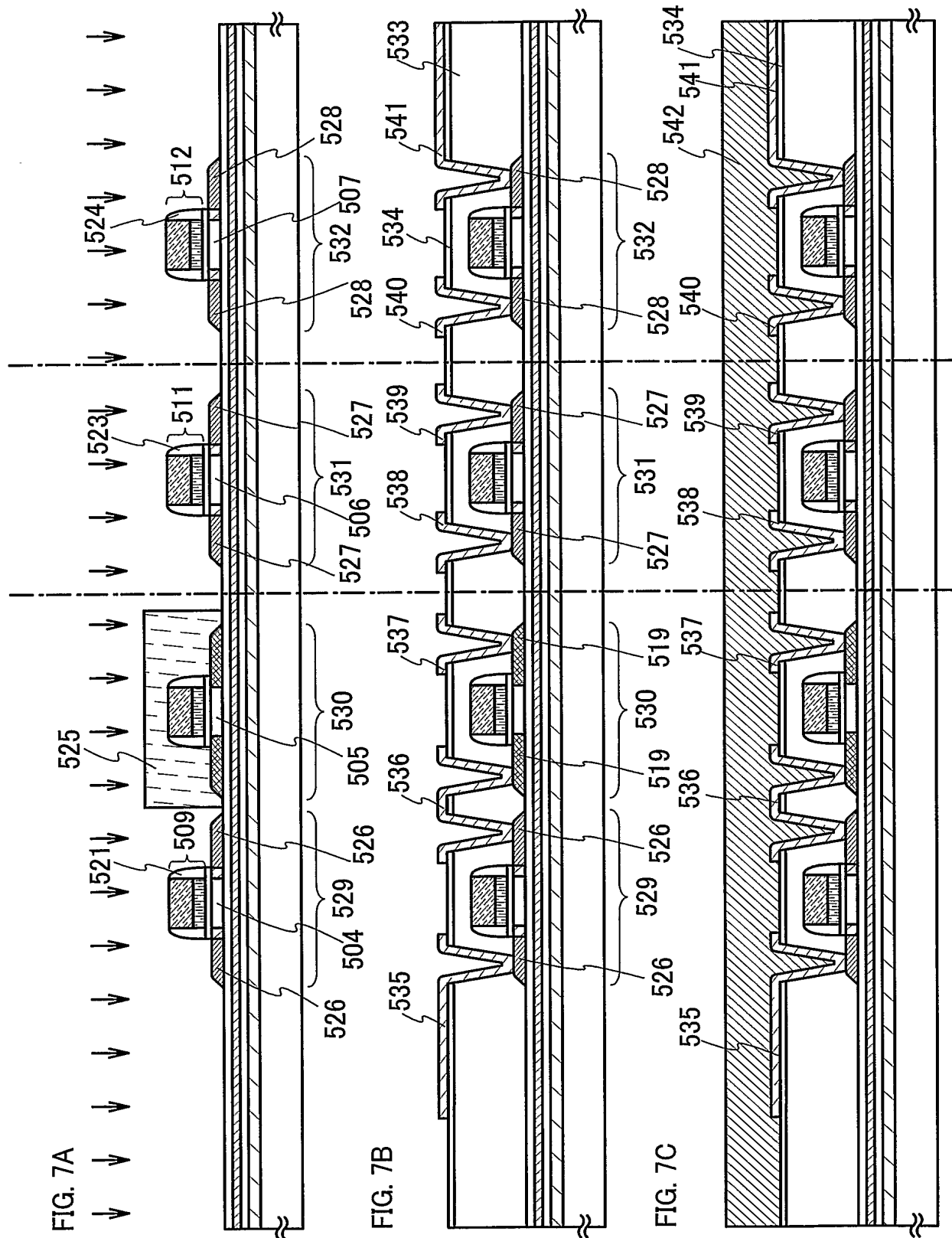


FIG. 8A

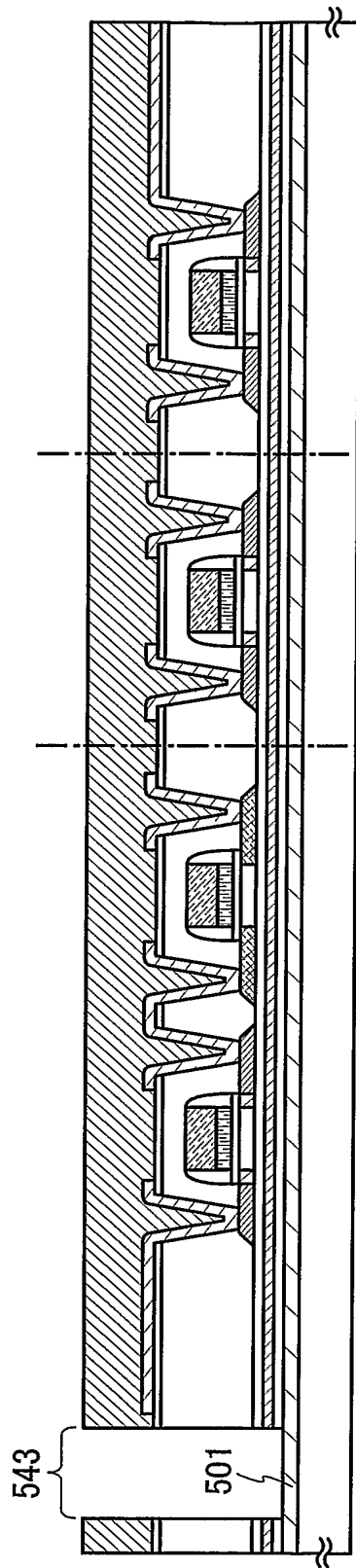


FIG. 8B

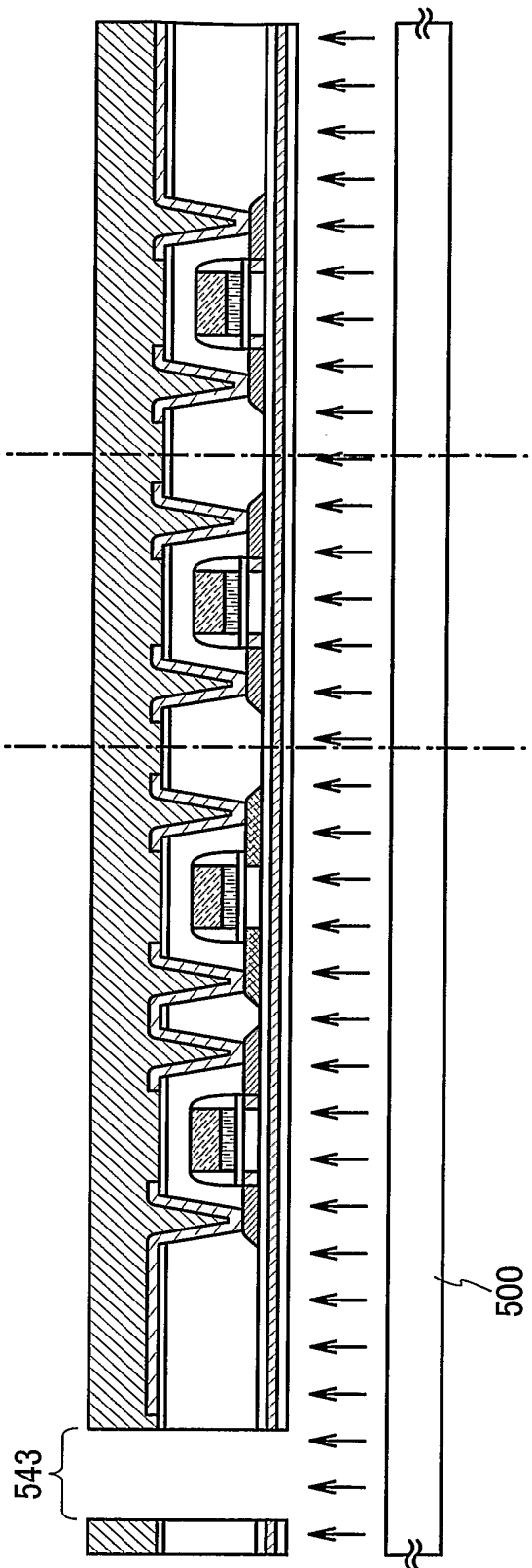




FIG. 9A

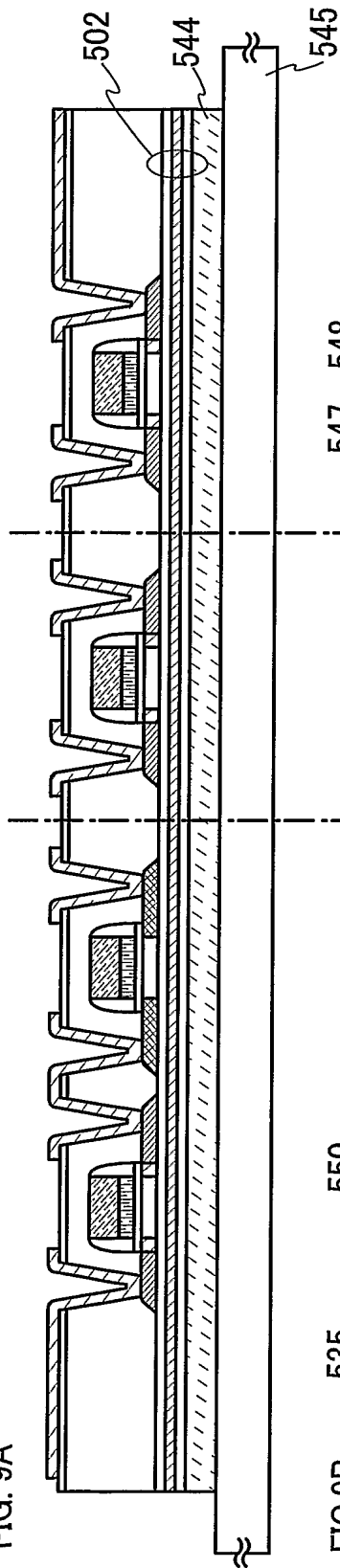


FIG. 9B

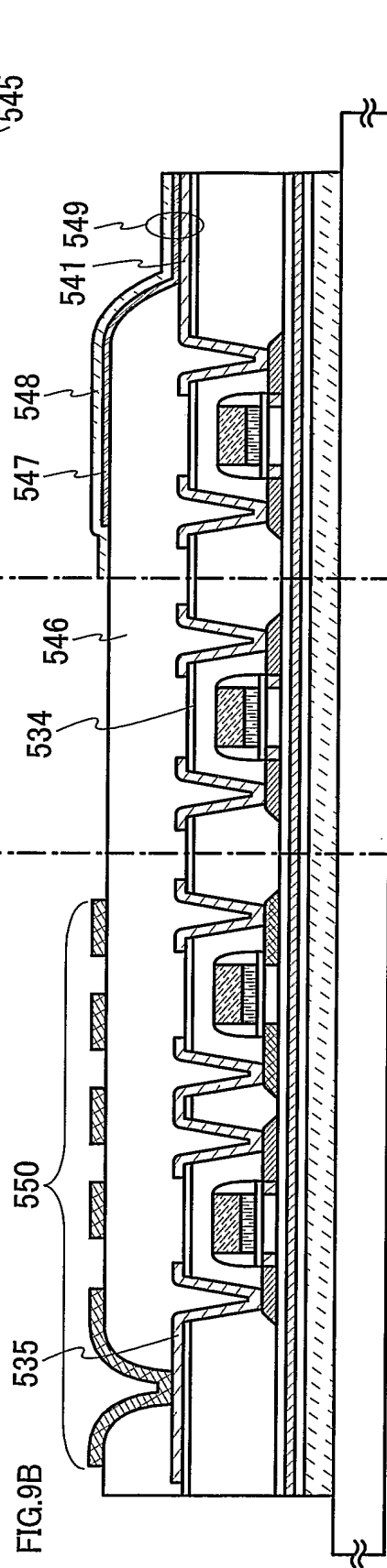
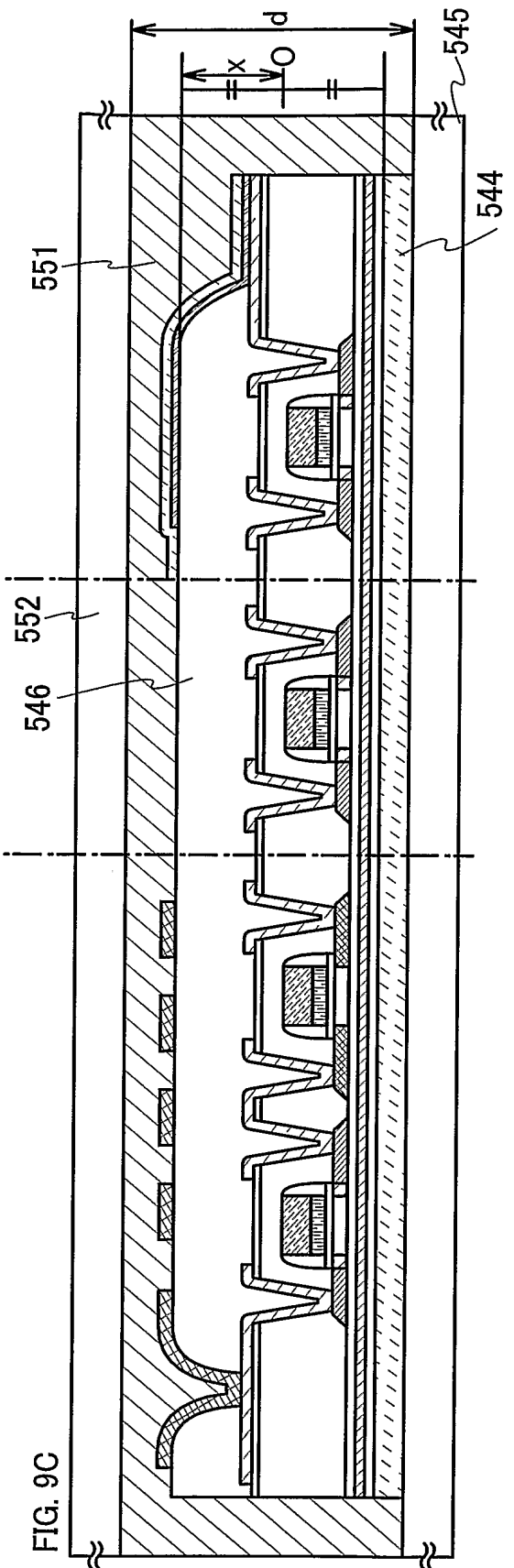


FIG. 9C



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FIG. 10

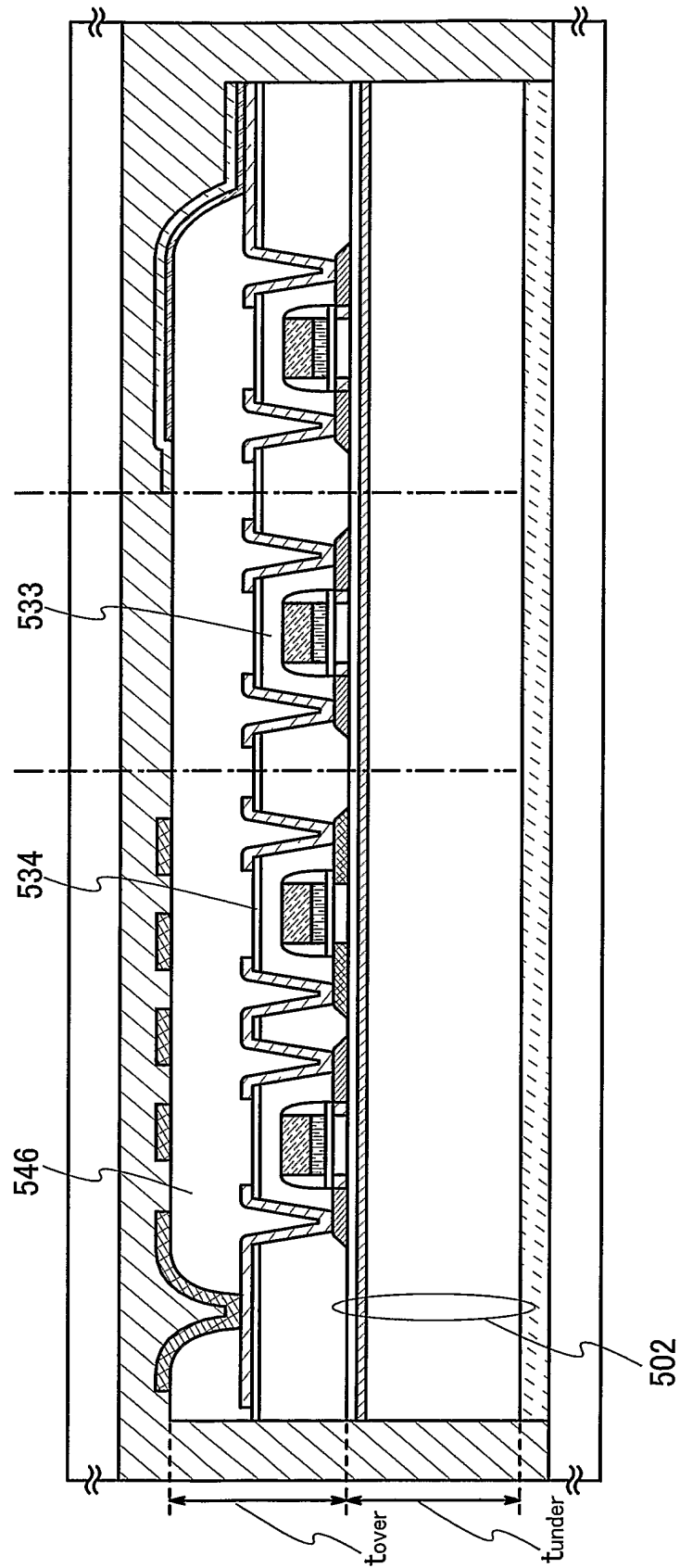


FIG. 11A

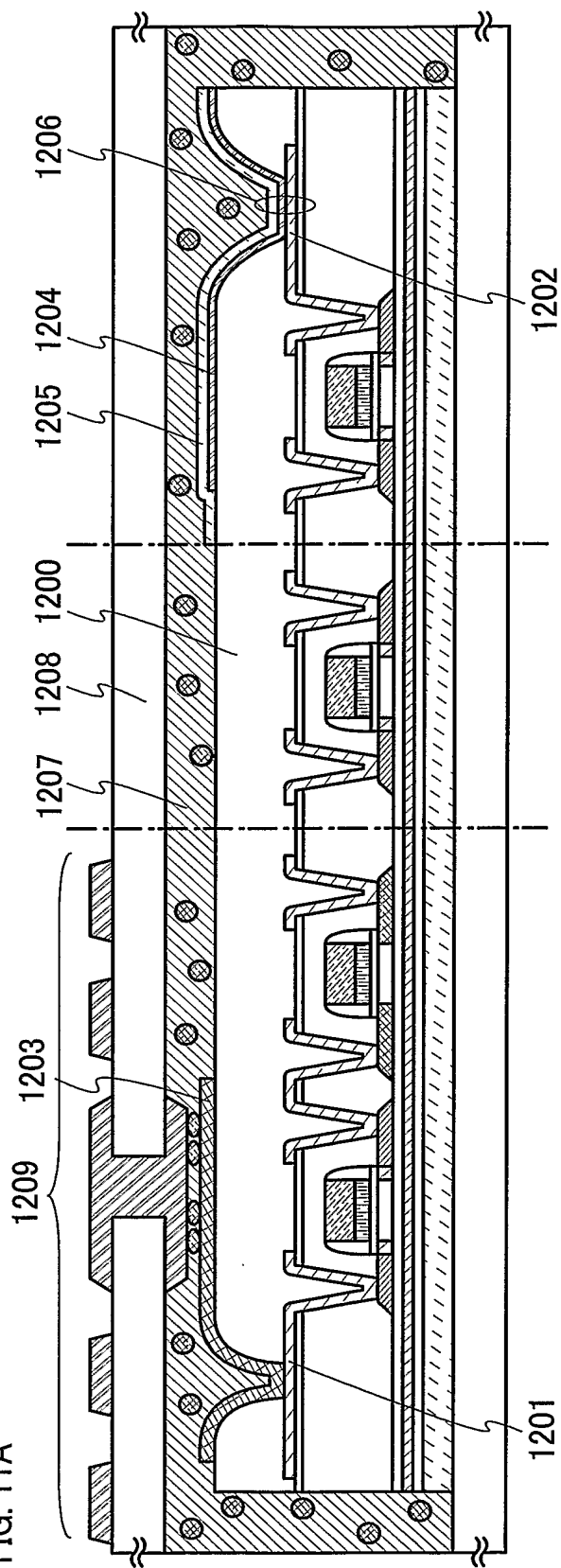
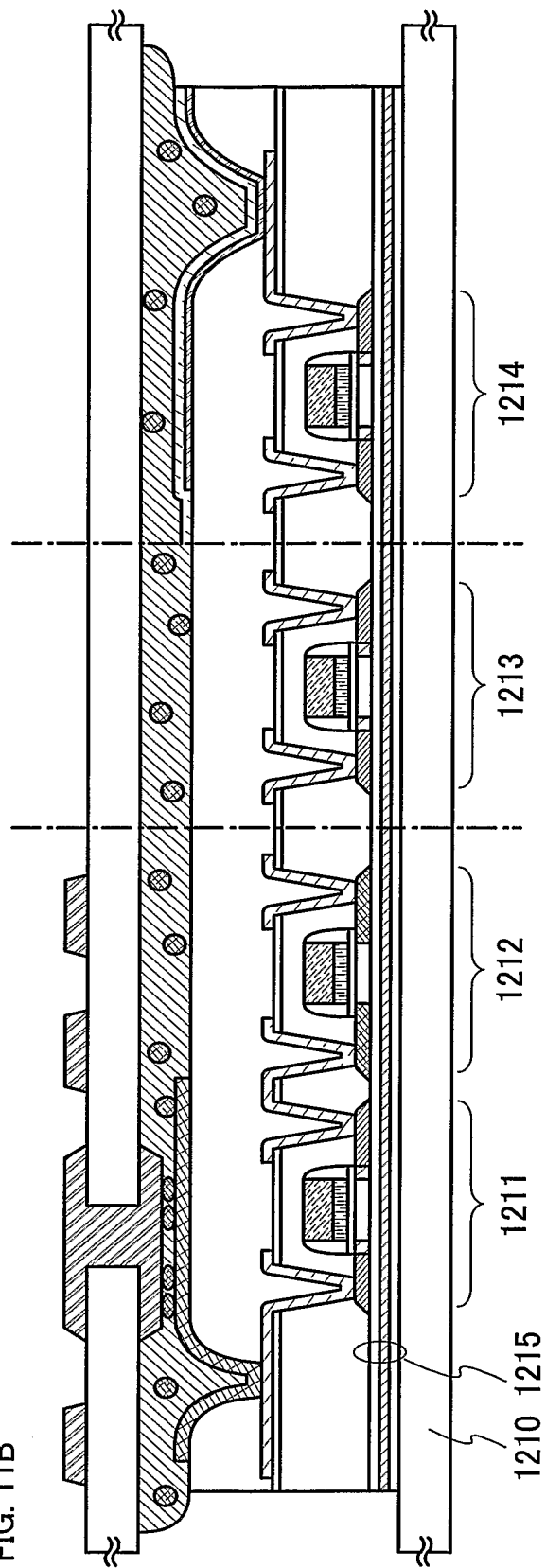


FIG. 11B



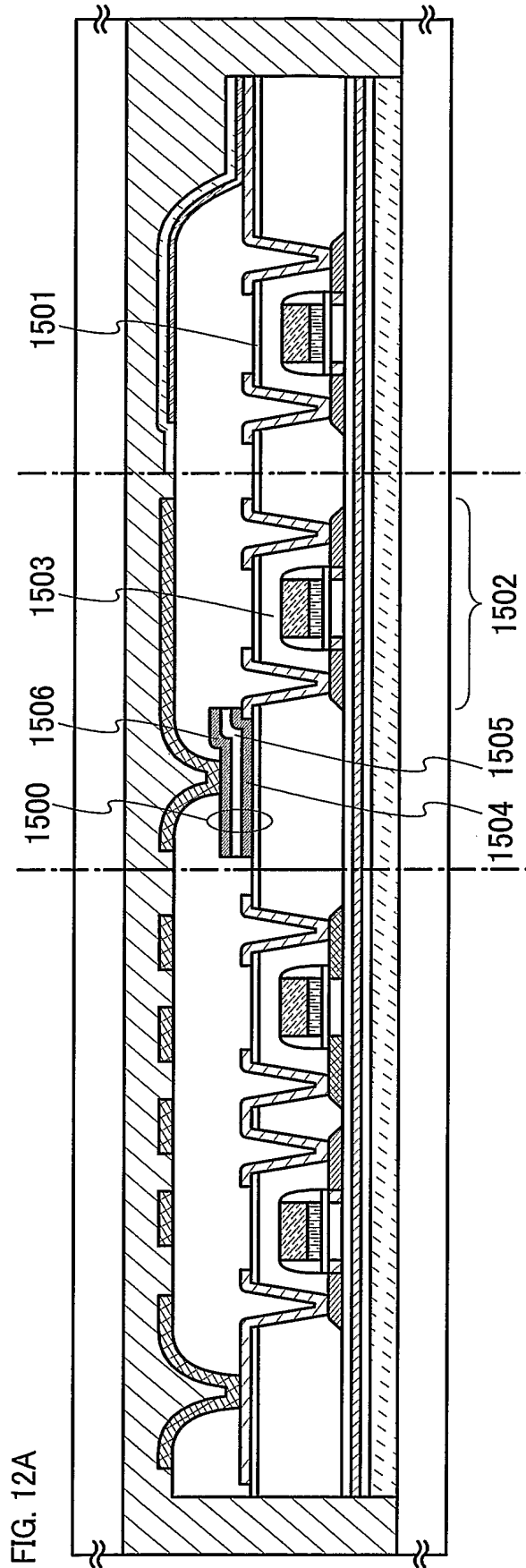


FIG. 12A

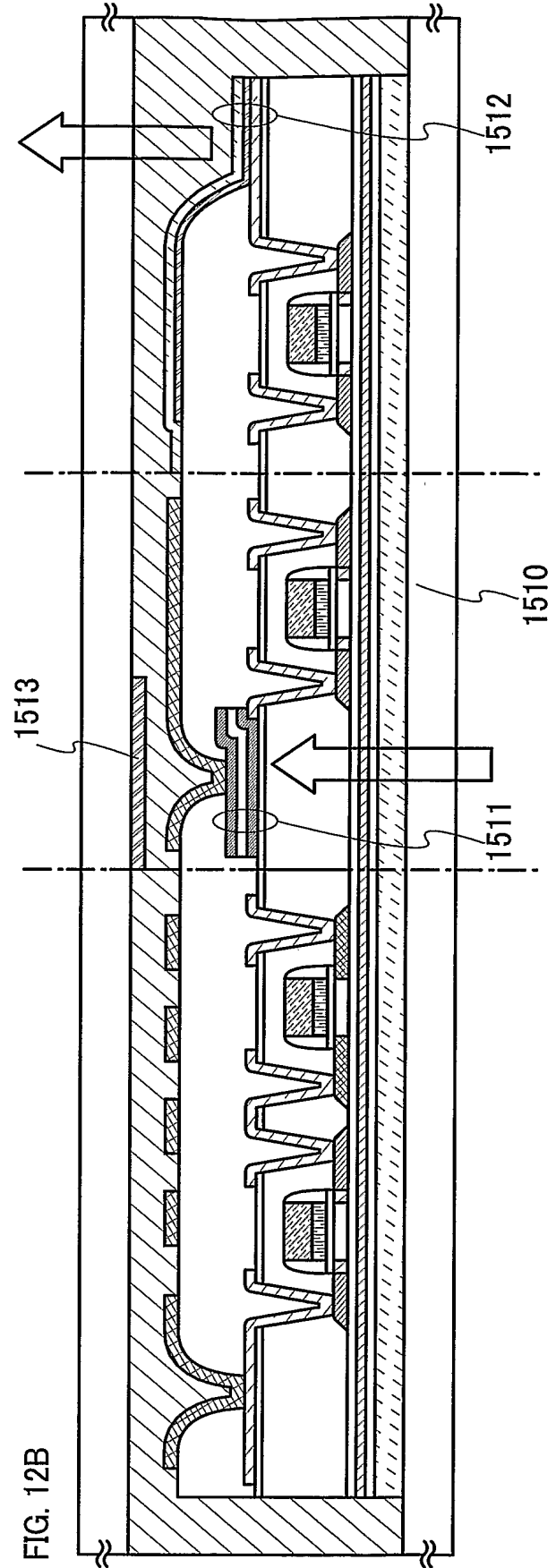


FIG. 12B

FIG. 13A

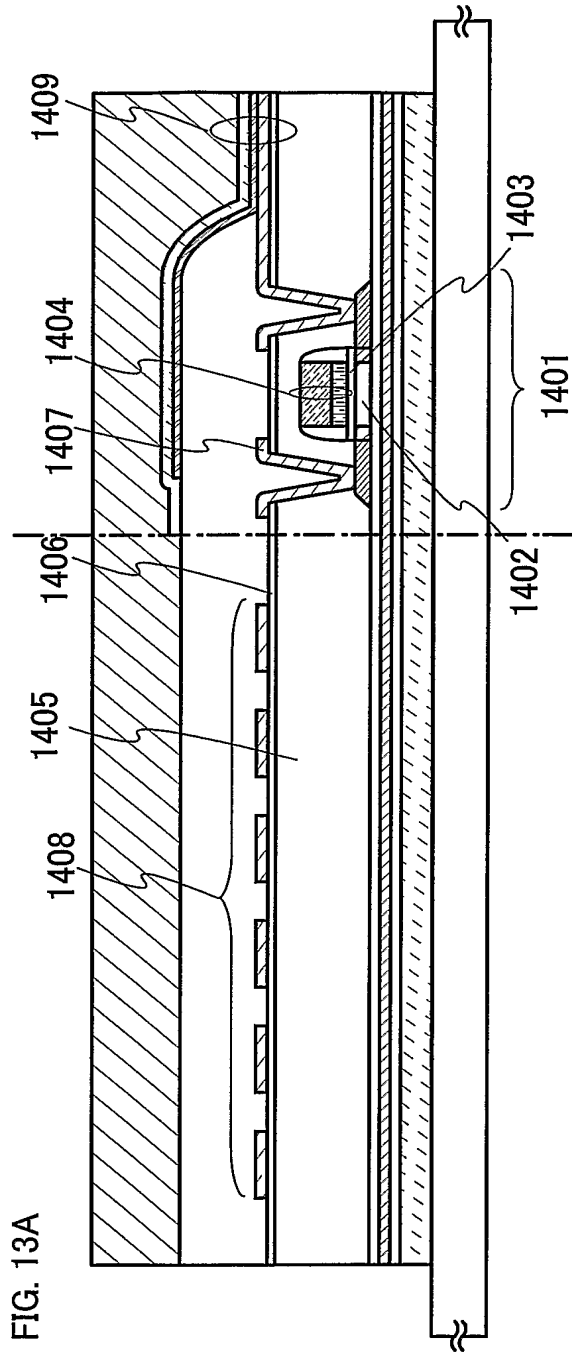
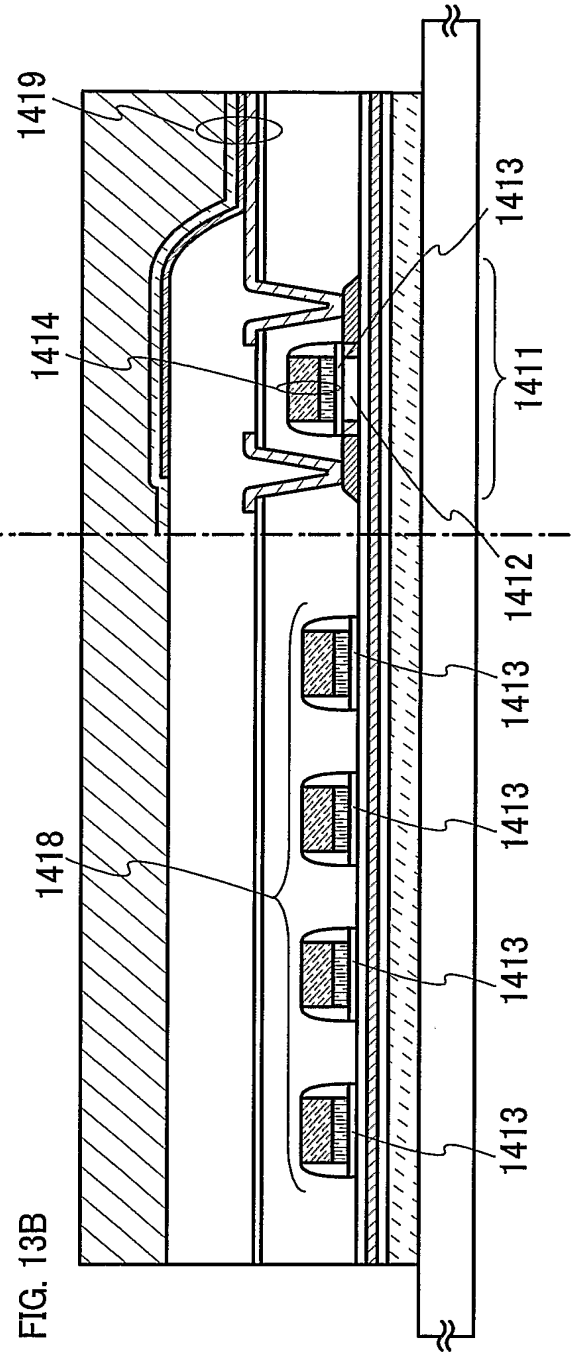


FIG. 13B



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FIG. 14A

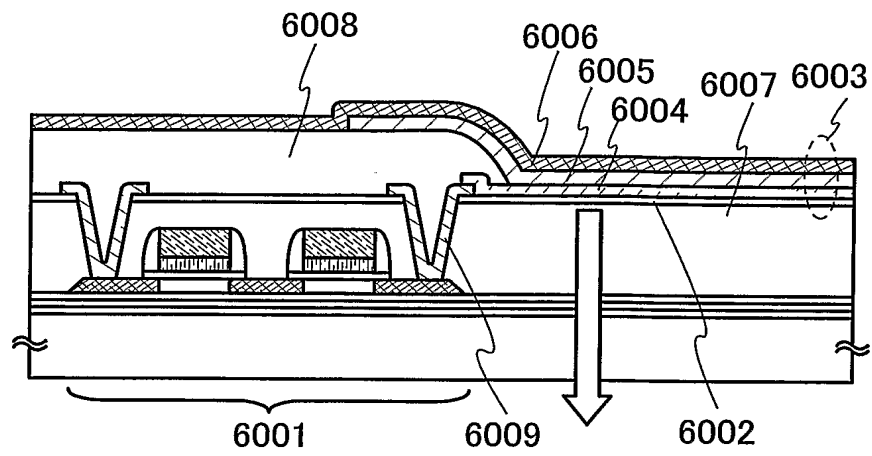


FIG. 14B

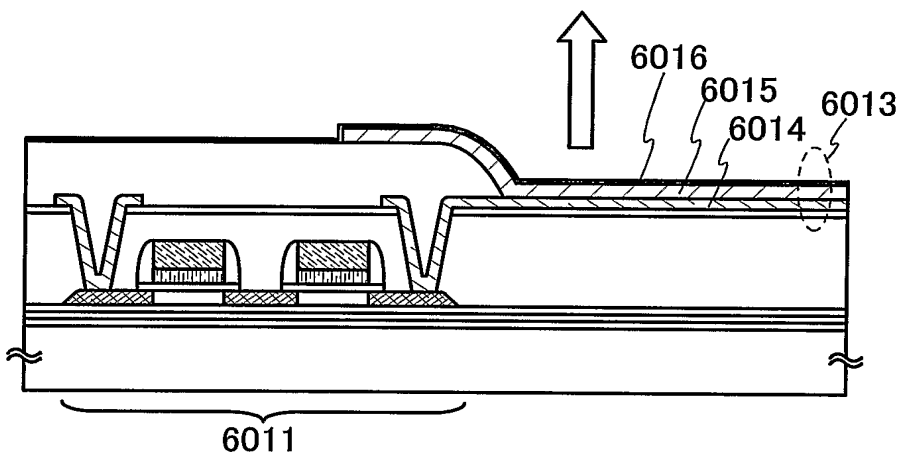


FIG. 14C

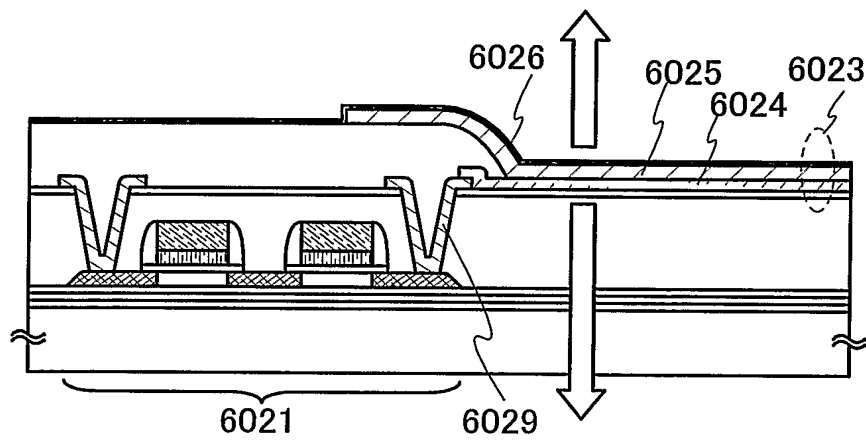


FIG. 15A

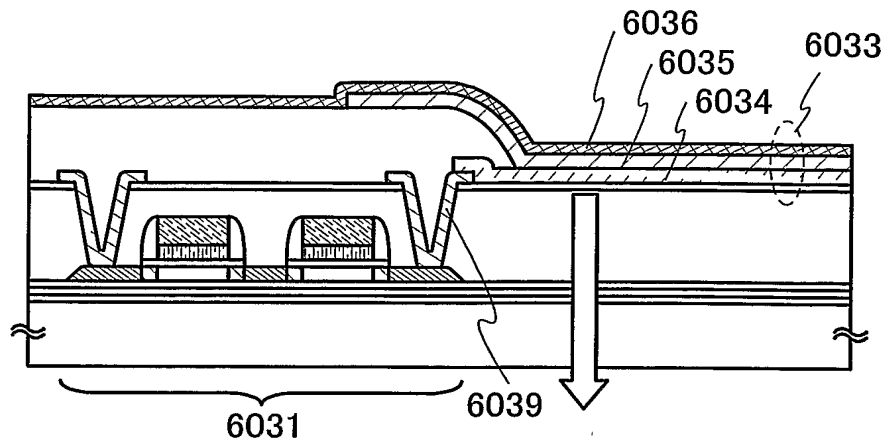


FIG. 15B

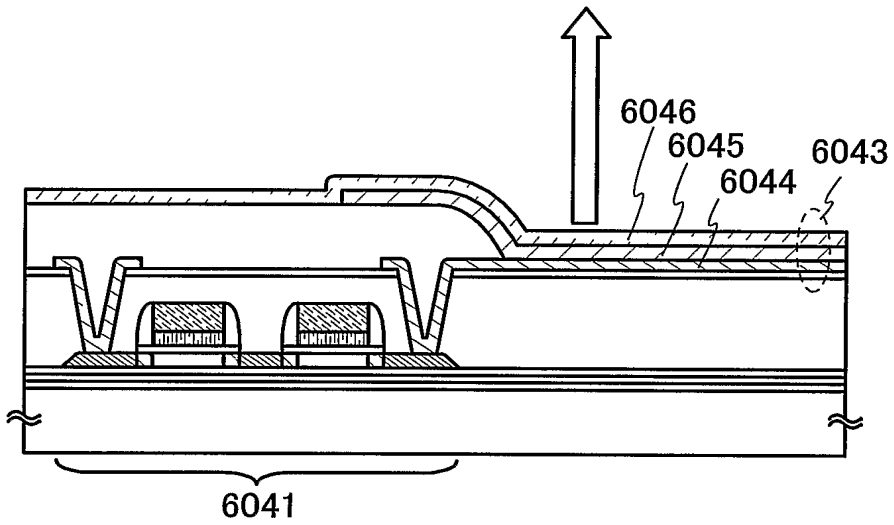


FIG. 15C

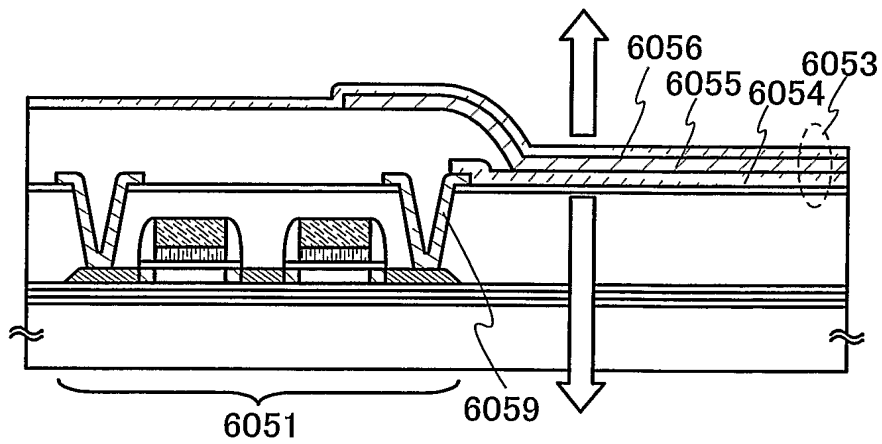


FIG. 16A

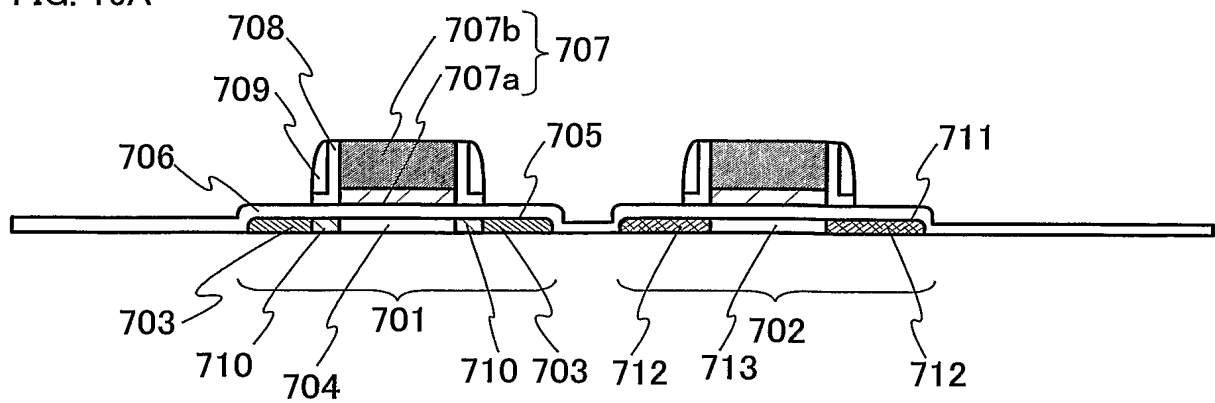


FIG. 16B

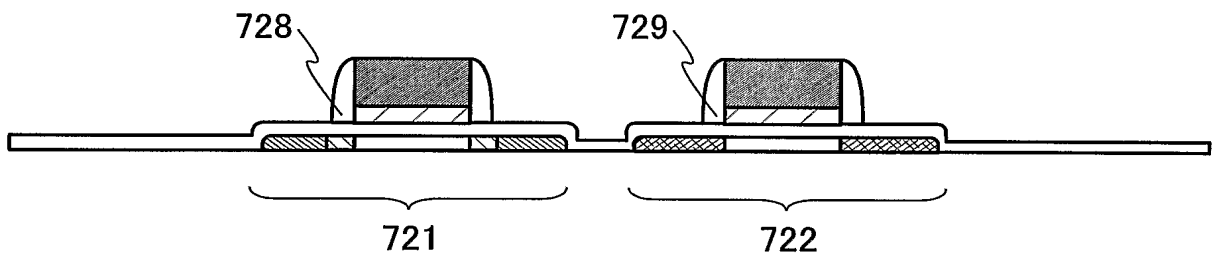
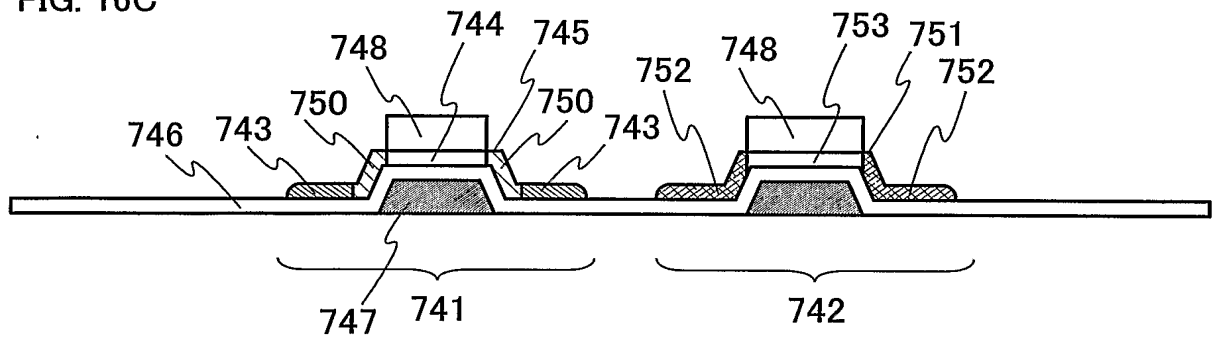


FIG. 16C





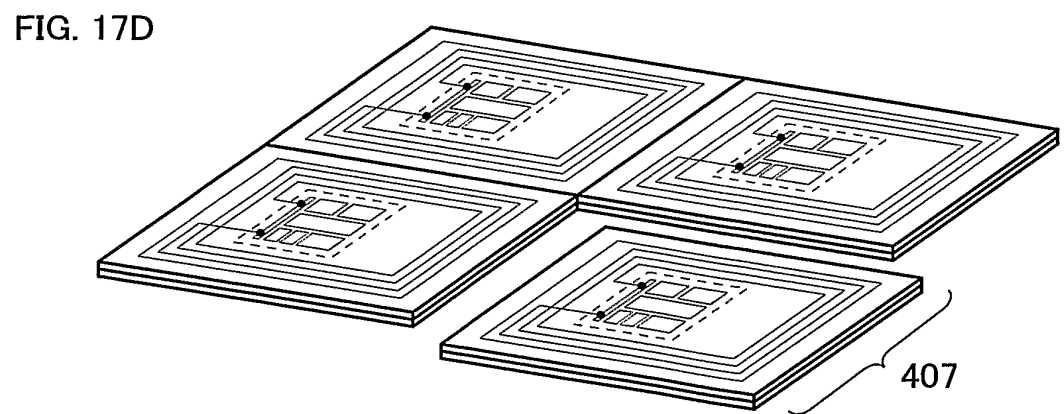
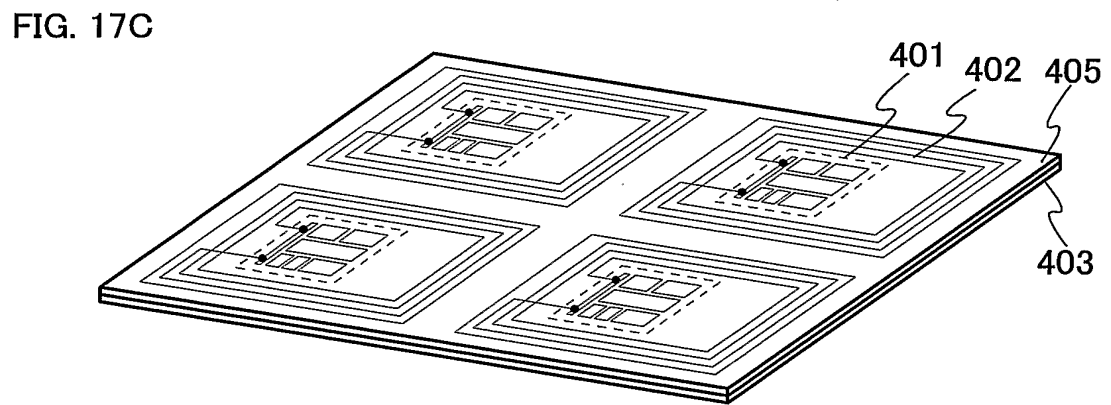
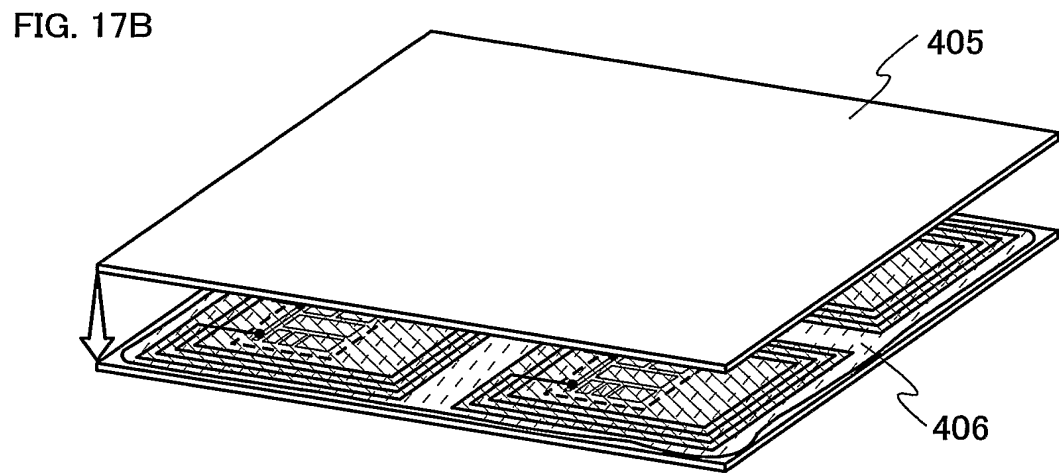
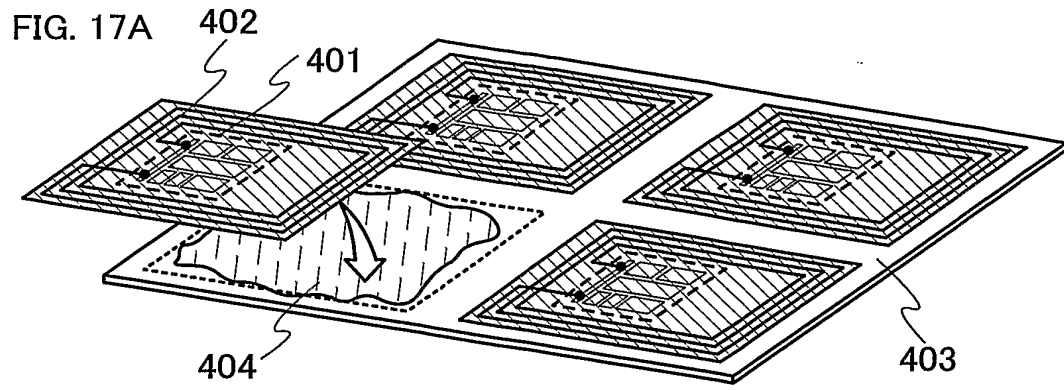


FIG. 18A

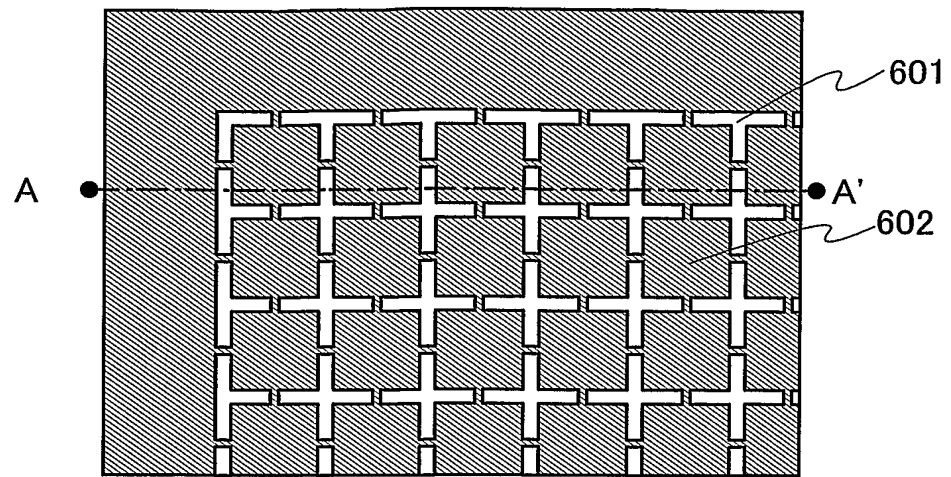


FIG. 18B

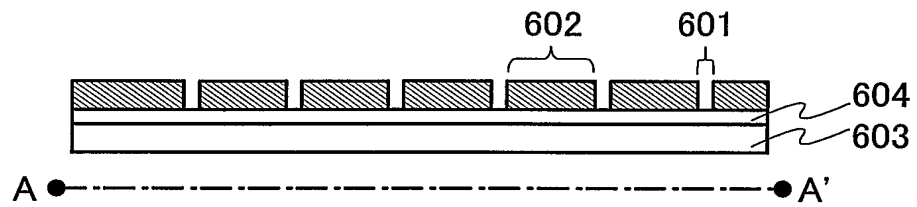


FIG. 18C

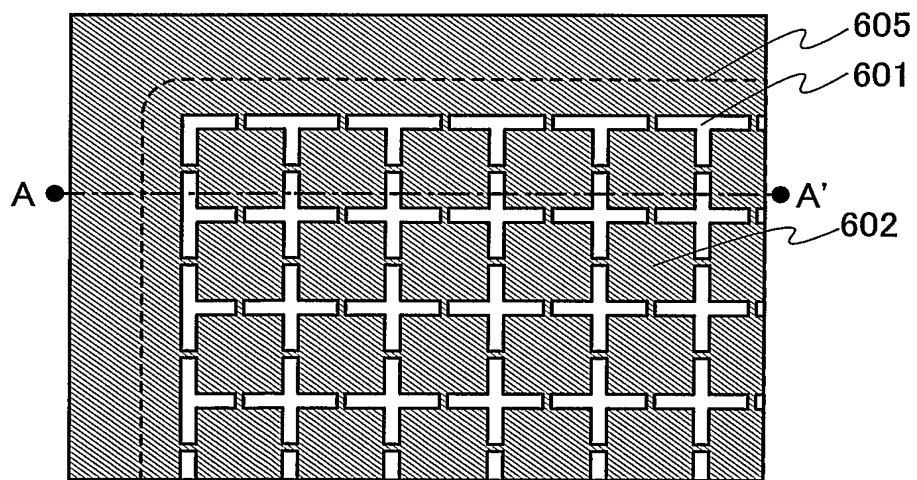


FIG. 18D

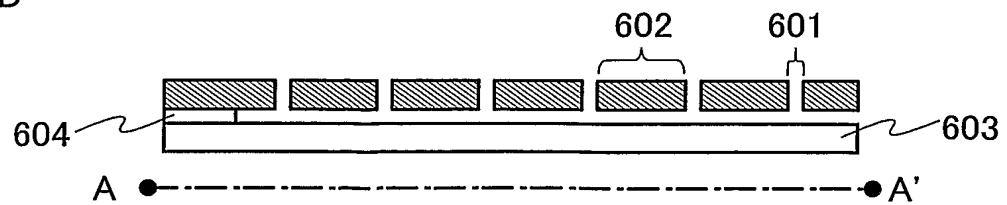


FIG. 19A

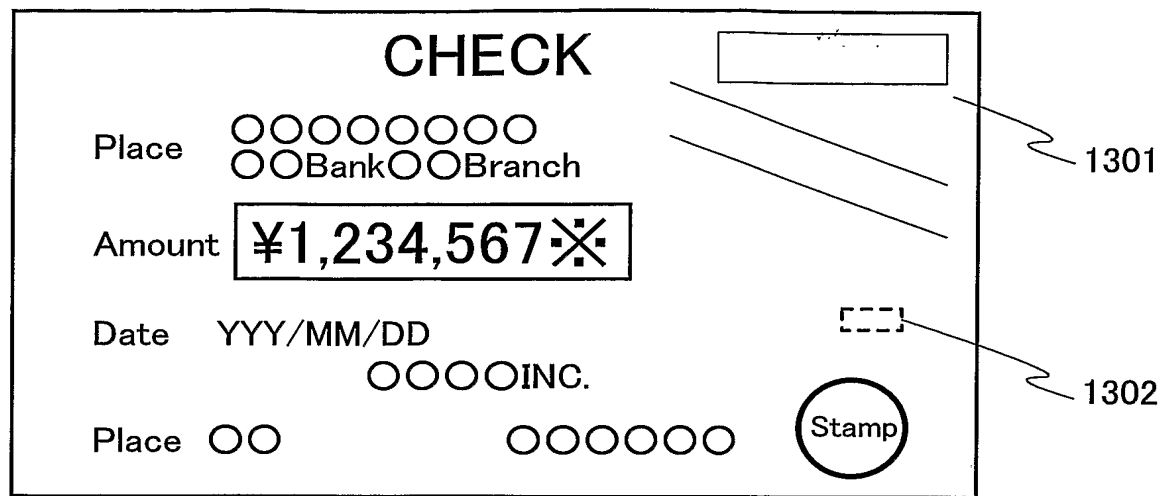


FIG. 19B

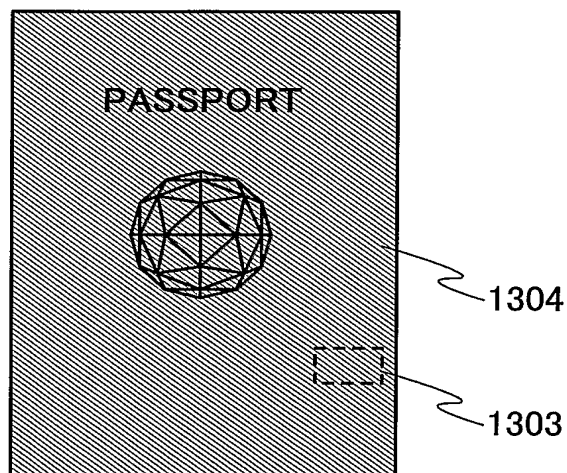
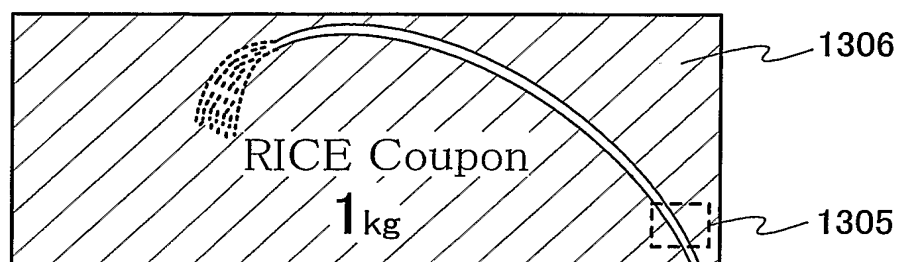


FIG. 19C



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FIG. 20A

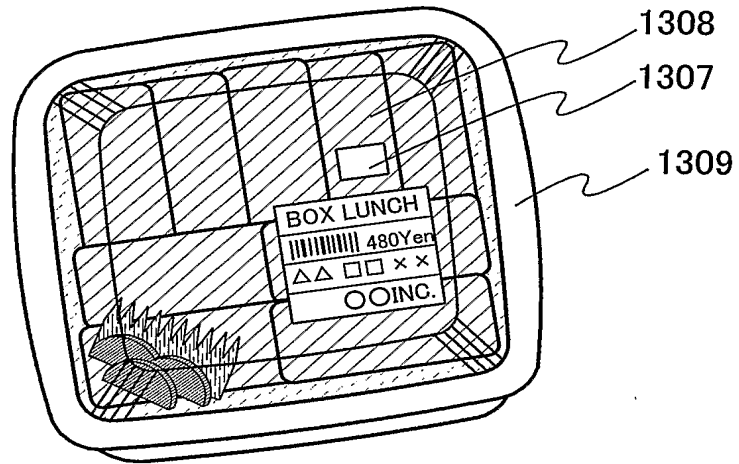
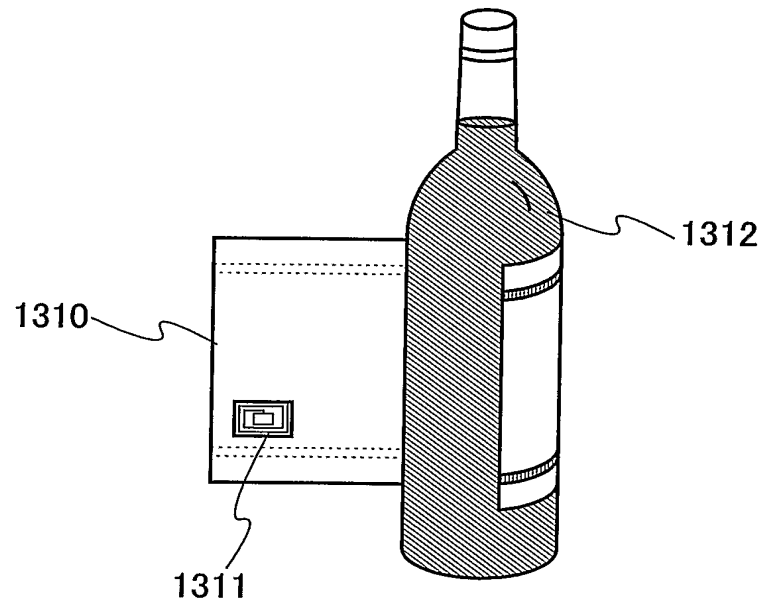


FIG. 20B



## EXPLANATION OF REFERENCE

100: integrated circuit, 101: light-receiving element, 102: light-emitting element, 103: antenna, 104: substrate, 105: cover material, 110: rectification circuit, 111: power supply  
5 circuit, 112: demodulation circuit, 113: logic circuit, 114: memory, 115: memory control circuit, 116: amplifier, 117: amplifier, 201: card body, 202: pixel portion, 203: light-receiving element, 204: light-emitting element, 205: substrate, 206: integrated circuit, 207: display device, 208: antenna, 210: rectification circuit, 211: power supply circuit, 212: demodulation circuit, 213: logic circuit, 214: memory, 215: memory  
10 control circuit, 216: amplifier, 217: amplifier, 218: control circuit, 219: signal line driver circuit, 220: scanning line driver circuit, 301: battery, 303: solar battery, 401: integrated circuit, 402: antenna, 403: substrate, 404: adhesive agent, 405: cover material, 406: adhesive agent, 407: IC card, 500: substrate, 501: separation layer, 502: base film, 503: semiconductor film, 504: semiconductor film, 505: semiconductor film, 508: gate  
15 insulating film, 509: gate electrode, 510: gate electrode, 513: resist, 514: resist, 515: low concentration impurity region, 518: resist, 519: high concentration impurity region, 520: insulating film, 521: sidewall, 525: resist, 526: high concentration impurity region, 527: high concentration impurity region, 528: high concentration impurity region, 529: n-channel TFT, 530: p-channel TFT, 531: n-channel TFT, 532: n-channel TFT, 533: interlayer insulating film, 534: interlayer insulating film, 535: wiring, 536: wiring, 538: wiring, 540: wiring, 541: wiring, 542: protective layer, 543: groove, 544: adhesive agent, 545: substrate, 546: bank, 547: electroluminescent layer, 548: electrode, 549: light-emitting element, 550: antenna, 551: adhesive agent, 552: cover material, 601: groove, 602: integrated circuit, 603: substrate, 604: separation layer, 605: broken line,  
25 701: n-channel TFT, 702: p-channel TFT, 703: impurity region, 704: channel formation region, 705: semiconductor film, 706: gate insulating film, 707: gate electrode, 707a: conductive film, 708: sidewall, 709: sidewall, 710: LDD (Lightly Doped Drain) region, 711: semiconductor film, 712: impurity region, 713: channel formation region, 721: n-channel TFT, 722: p-channel TFT, 728: sidewall, 741: n-channel TFT, 742: p-channel  
30 TFT, 743: impurity region, 744: channel formation region, 745: semiconductor film,

746: gate insulating film, 747: gate electrode, 748: protective film, 750: LDD (Lightly Doped Drain) region, 751: semiconductor film, 752: impurity region, 753: channel formation region, 1200: bank, 1201: wiring, 1202: wiring, 1203: terminal, 1204: electroluminescent layer, 1205: electrode, 1206: light-emitting element, 1207: adhesive agent, 1208: cover material, 1209: antenna, 1210: substrate, 1211: semiconductor element, 1215: base film, 1301: check, 1302: ID chip, 1303: ID chip, 1304: passport, 1305: ID chip, 1306: gift certificate, 1307: ID chip, 1308: packing material, 1309: boxed meal, 1310: label, 1311: ID chip, 1312: product, 1401: TFT, 1402: semiconductor film, 1403: gate insulating film, 1404: gate electrode, 1405: interlayer insulating film, 1406: interlayer insulating film, 1407: wiring, 1408: antenna, 1409: light-emitting element, 1411: TFT, 1412: semiconductor film, 1413: gate insulating film, 1414: gate electrode, 1418: antenna, 1419: light-emitting element, 1500: photodiode, 1501: interlayer insulating film, 1502: TFT, 1503: interlayer insulating film, 1504: cathode, 1505: photoelectric conversion layer, 1506: anode, 1510: substrate, 1511: photodiode, 1512: light-emitting element, 1513: shielding film, 6001: TFT, 6002: interlayer insulating film, 6003: light-emitting element, 6004: electrode, 6005: electroluminescent layer, 6006: electrode, 6007: interlayer insulating film, 6008: bank, 6009: wiring, 6011: TFT, 6013: light-emitting element, 6014: electrode, 6015: electroluminescent layer, 6016: electrode, 6021: TFT, 6023: light-emitting element, 6024: electrode, 6025: electroluminescent layer, 6026: electrode, 6029: wiring, 6031: TFT, 6033: light-emitting element, 6034: electrode, 6035: electroluminescent layer, 6036: electrode, 6039: wiring, 6041: TFT, 6043: light-emitting element, 6044: electrode, 6045: electroluminescent layer, 6046: electrode, 6051: TFT, 6053: light-emitting element, 6054: electrode, 6055: electroluminescent layer, 6056: electrode, 6059: wiring